	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	31643	(insulat$3 or dielectric) near15 (metal or copper) near15 (via or hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:18
2	BRS	L2	8717	((insulat$3 or dielectric) near15 (metal or copper) near15 (via or hole)) near25 (board or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:18
3	BRS	L3	2245	((insulat$3 or dielectric) near15 (metal or copper) near15 (via or hole)) near25 (board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:18

	Type	L #	Hits	Search Text	DBs	Time Stamp
4	BRS	L4	823	((insulat$3 or dielectric) near15 (metal or copper) near15 (via)) near25 (board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:20
5	BRS	L5	14	((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 via)) near25 (board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:31
6	BRS	L6	154	((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:10

	Type	L #	Hits	Search Text	DBs	Time Stamp
7	BRS	L7	0	((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board) near25 (trace$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:57
8	BRS	L8	2	((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board) same (trace$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:58
9	BRS	L9	2	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board)) same (trace$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:59

	Type	L #	Hits	Search Text	DBs	Time Stamp
10	BRS	L10	11	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board)) and (trace$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 09:59
11	BRS	L11	29	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board)) and (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:01
12	BRS	L12	2	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (board)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:01

	Type	L #	Hits	Search Text	DBs	Time Stamp
13	BRS	L13	1	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 via)) near25 (board)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:02
14	BRS	L14	0	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 opening)) near25 (board)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:03
15	BRS	L15	1	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 opening)) near25 (substrate)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:03

	Type	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L16	9	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 hole)) near25 (substrate)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_T DB	2005/01/19 10:06
17	BRS	L17	1	(((insulat$3 or dielectric) near15 (metal or copper) near15 (wall near3 via)) near25 (substrate)) same (cut$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_T DB	2005/01/19 10:07
18	BRS	L18	1795	((insulat$3 or dielectric) near15 (metal or copper) near15 (hole)) near25 (board)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_T DB	2005/01/19 10:11

	Type	L #	Hits	Search Text	DBs	Time Stamp
19	BRS	L19	25	((insulat$3 or dielectric) near15 (metal or copper) near15 (hole)) near25 (board) near25 (cut$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:14
20	BRS	L20	11	((insulat$3 or dielectric) near15 (metal or copper) near15 (via)) near25 (board) near25 (cut$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:16
21	BRS	L21	7	((insulat$3 or dielectric) near15 (metal or copper) near15 (opening)) near25 (board) near25 (cut$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:16

	Type	L #	Hits	Search Text	DBs	Time Stamp
22	BRS	L22	15	((insulat$3 or dielectric) near15 (metal or copper) near15 (opening)) near25 (substrate) near25 (cut$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2005/01/19 10:17